

Renesas Synergy™ Platform

S7 Series MCU Diagnostic Software User Guide

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Introduction

IEC 61508 is an international standard governing a range of electrical, electromechanical, and electronic safety related systems. It defines the requirements needed to ensure that systems are designed, implemented, operated, and maintained at the required Safety Integrity Level (SIL). Four SIL levels have been defined to indicate the risks involved in any particular system, with SIL4 being the highest risk level.

At the heart of the majority of safety related systems nowadays is a sophisticated and often highly integrated Microcontroller (MCU). An integral part of meeting the requirements of IEC61508 is the ability to verify the correct operation of the critical areas of the MCU.

The Renesas Diagnostics Software is designed for use with the Synergy S7 Microcontroller Family. Tests are provided for coverage of the following critical areas of MCU operation: the Central Processing Unit (CPU), embedded flash ROM memory, embedded RAM memory, the main clock structure (main clock oscillator, PLL, MUX generating ICLK), and Vcc power supply

The code was developed using the functional safety version 8.23.17132 of the IAR Embedded Workbench for ARM, which is certified by the TÜV SÜD certification body, and in accordance with IEC61508:2010 for use in safety related applications up to SIL3 level. This is also the systematic capability for the Renesas Diagnostics Software described in this document.

Note: In the code, some pragmas have been added in the form of comments, for example, "/*LDRA_INSPECTED 90 S Basic type declaration used. */", which have been used to mark code lines flagged to potentially violate a specific MISRA rule, but judged as safe. See Appendix C – Pragmas report for details of the pragmas inserted.

Target Device

Synergy S7 Series MCU

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1. Common Terminology

This section defines some common terms and acronyms used throughout the document and provides references to other relevant Renesas documentation.

1.1 Acronyms

Acronym	Description	
CRC	Cyclic Redundancy Check	
LUT	Look Up Table	
TS	Test Segment	
TS_ID	Test Segment Identifier	
WD Watch Dog		

2. Compiler Environment

The diagnostic software code was developed using the functional safety version 8.23.1.17132 IAR Embedded Workbench for ARM, certified by the TÜV SÜD certification body, for use in safety related applications up to level SIL3.

2.1 **C Type Implementation**

Integer C variables are assumed to be 32-bit implemented. Please, make sure that int type is represented in 32-bit format in the target environment.

2.2 IAR Environment Settings

The IAR environment should be set up as specified in Table 2-1.



Table ID	Category	Sub-category	Setting description	Comment
1	General options	Target	 Device := Renesas R7FS7G27H Floating-point, Size of type 'double' := 32bits Subnormal numbers := Treat as zero 	
			 Int, Size of type 'int' := 32bits 	
0	0	1.1	Data model := Far	
2	General options	Library configuration	Library := Normal DLIB	
3	General options	Stack/Heap	 Privileged mode stack size := 0x1000 	Consider this setting to be typical. The stack size has to be greater than the one specified in the Resources Usage section.
4	C/C++ Compiler	Language1 Language := C C dialect := C99 Language conformance := Standard with IAR extensions		
5	C/C++ Compiler	Language2	Floating-point semantics := Strict conformance	
6	C/C++ Compiler	Code	 Align functions := 1 no alignment 	
7	C/C++ Compiler	Optimizations	Level := None	
8	Assembler	Language	User symbols are case sensitive	
13	Linker	Library	Automatic runtime library selection	
14	Linker	Others sub- category	For RAM test specific testin For ROM test specific testin	-
15	Build actions	For RAM test sp	Decific testing see section 4 pecific testing see section 5.	~

Table 2-1 IAR project options

3. CPU Software Test

3.1 Test Objectives

The objective of the CPU software test is to verify the correct functionality of the CPU by adopting a predominantly instruction based diagnosis, with the aim of detecting permanent hardware failures of the CPU core.

All instructions, with the exceptions of BKPT, SEV, WFE, WFI, and DMB, are used in the CPU core testing scheme.

See reference document [REF.1] for the complete list of instructions. The primary aim is not to test individual instructions, but to detect a hardware failure of the CPU core.

3.2 Software Structure

The software structure provides two different levels of functions calls:

A. The first level is the user interface function named coreTest.



B. The second, lower level functions are named testSegment that are called by coreTest.

The testSegment functions execute the actual diagnostic of the core, while the coreTest allows the user to select and run one or more of the testSegment functions in sequence and to collect the diagnostic results.

Up to 20 testSegment functions are available, from testSegment0 to testSegment19. Table 3-1 provides an overview of the testSegment functions.

Two types of testSegment functions are defined as follows:

- testSegment of type "Fixed":
 - Operand data necessary to stimulate the core and run these functions is embedded in the code.
- testSegment of type "LUT":
 - These functions can be called with different operand data taken from a Look Up Table.

TS_ID	Function Name	Objective of the Test	Test Segment Type
TS00	testSegment00	Testing of Jump instructions (using control flow) Fixed	
TS01	testSegment01	Logical instructions as AND, EOR, NOT, BIC Fixed	
TS02	testSegment02	Bit-level manipulation and test instructions as Fixed REVERSE, TEQ	
TS03	testSegment03	Floating point multiply instructions	LUT
TS04	testSegment04	Floating point addition/subtractions instructions plus additional floating points conversion instructions as VCVT and VCVTB	LUT
TS05	testSegment05	Floating point division instructions plus additional floating point instruction as VABS, VNEG and VCVT	LUT
TS06	testSegment06	Saturating instructions plus additional floating points conversion instructions as VCVT	Fixed
TS07	testSegment07	CPU Control Registers	Fixed
TS08	testSegment08	Integer multiply instructions using LUT data with MULS. (32bit results)	LUT
TS09	testSegment09	Divide instructions	LUT
TS10	testSegment10	Load and store using GPR only	Fixed
TS11	testSegment11	Floating point normalize and denormalized tests	Fixed
TS12	testSegment12	Load and store using floating point data registers Fixed plus floating point read port 0 and 1 tests	
TS13	testSegment13	Integer multiply using LUT data with UMUL and LUT SMUL instruction. (64bit result)	
TS14	testSegment14	FPU control register plus FPU extension registers Fixed and VSUB and conversion instruction Fixed	
TS15	testSegment15	Shift and rotate instructions Fixed	
TS16	testSegment16	Integer addition and subtract instructions LUT	
TS17	testSegment17	Bit field instructions plus internal core register tests Fixed	
TS18	testSegment18	Packing and unpacking instructions Fixed	
TS19	testSegment19	Floating point square root plus internal core register tests	LUT

Table 3-1 Test segment overview

Table 3-2 reports the association of the execution progress versus the testSegment to be executed, and the related data set for LUT testSegment.

The execution order of the Test Segments (TSs) follows the order defined in Table 3-2 and the coreTestInit function is used to initialize the sequence.



The concept is to allow the user to select the number of steps to be performed by the coreTest function, so that the user can control the execution progress of the CPU core test. If the user has specific execution time constraints, the user can decide how many steps execute for the execution time constraints to be fulfilled.

Execution progress	Test Segment	Dataset (if applicable)
0	testSegment00	NA
1	testSegment01	NA
2	testSegment02	NA
3	testSegment03	Float32_MUL_set0
4	testSegment04	Float32_ADD_set0
5	testSegment05	Float32_DIV_set0
6	testSegment06	NA
7	testSegment07	NA
8	testSegment08	Int32_MUL_set0
9	testSegment09	Int32_DIV_set0
10	testSegment10	NA
11	testSegment11	NA
12	testSegment12	NA
13	testSegment13	Int32_UMUL_set0
14	testSegment14	NA
15	testSegment15	NA
16	testSegment16	Int32_ADD_set0
17	testSegment17	NA
18	testSegment18	NA
19	testSegment19	Float32_SQRT_set0
20	testSegment08	Int32_MUL_set1
21	testSegment08	Int32_MUL_set2
22	testSegment09	Int32_DIV_set1
23	testSegment09	Int32_DIV_set2
24	testSegment16	Int32_ADD_set1
25	testSegment16	Int32_ADD_set2
26	testSegment03	Int32_MUL_set0
27	testSegment03	Int32_MUL_set1
28	testSegment03	Int32_MUL_set2
29	testSegment04	Int32_ADD_set0
30	testSegment04	Int32_ADD_set1
31	testSegment04	Int32_ADD_set2

Table 3-2 Association of execut	ion steps with respec	t to testSegment
---------------------------------	-----------------------	------------------

3.2.1 API and CPU Test Environment

All the testSegment functions are called through a main interface function named coreTest.

The coreTest function signature is defined as follows:

void coreTest(uint8_t steps, const uint8_t forceFail, uint32_t *result);

Table 3-3 describes the input and output of each function in more detail.



Using the forceFail input makes it possible to force the function to fail, that is, to return an error value. This type of software fault injection feature allows for testing of higher level fault handling mechanisms, specified at the application level.

Table ID	Parameter type	C type	Name	Description
1	Input	unsigned int 8 bit	steps	Specifies how many execution progresses have to be executed. Each execution of a LUT TS with a specific dataset counts for 1 step (see Table 3-2 for details on the association of testSegment to execution progress). Valid range of steps parameter is: 0 < steps < TOT_TESTSEGMENTS, where TOT_TESTSEGMENTS is the maximum number of execution progresses that could be performed in one run.
2	Input	const unsigned int 8 bit	forceFail	When set to 0, forces the function to fail, generating a failure signature that is the inverted value of the correct expected signature. All other values do not have any effect on the function behaviour.
3	Output	*unsigned int 32 bit	result	 Global pass/fail result of all executed TSs: 0 if at least one executed testSegment failed 1 if all executed testSegments passed 2 if steps input parameter is out-of-range (see Table 3-2 for the valid range information).

In order to correctly use coreTest function, two other functions, coreTestInit and getcoreTestStatus are provided.

The first one is the initialization function, written in C programming language, whose signature is defined as follows:

void coreTestInit(void)

The function has no input or output parameters, since it just initializes the different data structures needed for the correct execution of coreTest. In particular, it resets the pointer to the next execution progress to be executed. As a consequence, after coreTestInit is called, the next TS to be executed will be the testSegment00 (see Table 3-2).

The second function offers to the user the possibility to get the next execution progress, which will be executed in the next call of coreTest function.

The function is written in C programming language and its signature is defined as follows:

uint8_t getcoreTestStatus(void).

Table 3-4 describes the output of the function in more detail.

Table 3-4 getcoreTestStatus interface

Table ID	Parameter type	C type	Name	Description
1	Output	*unsigned int 8 bit	N/A	Indicates the next execution step to be executed

testSegments functions are implemented using ARM Cortex-M4 assembly code, with a C code interface.



Note that the need for a hardware low level control makes the use of an assembler necessary, for instance, when calling specific assembly instructions with specific parameters.

Since it is possible to have two types of testSegments (Fixed or LUT), we have the following two types of function signatures:

1. Fixed

```
void testSegmenty (const uint8_t forceFail, uint32_t *result) with y=00, 01, 02, 06, 07, 10, 11, 12, 14, 15, 17, 18.
2. LUT

void testSegmentx (const uint8_t forceFail, uint32_t *result, const uint32_t *StartDataSet, const uint32_t GoldSign) with x= 03, 04, 05, 08, 09, 13, 16, 19.
```

Table 3-5 describes input and output of the functions in more detail.

Table 3-5	testSegment	interface
-----------	-------------	-----------

Table ID	testSegment type	Parameter type	С туре	Name	Description
1	LUT or Fixed	input	const unsigned int 8 bit	forceFail	When set to 0, forces the TS to fail, generating a failure signature that is a non- inverted value of the proper signature. All other values do not have any effect on the function behavior.
2	LUT	input	const unsigned int 32 bit *	StartData Set	Start address of the Look Up Table for the selected dataset
3	LUT or Fixed	output	const unsigned int 32 bit	GoldSign	Result of signature value
4	LUT or Fixed	output	unsigned int 32 bit *	result	Pass/fail result of TSexecution0 if TS failed1 if TS passed.

3.3 Software Integration Rules

This section provides guidelines for how to integrate the CPU test software within the user project.

3.3.1 Code Integration

Environment for coreTest call

To call the coreTest function:

```
1. Include coreTest.h.
```

- 2. Create a variable to hold the result of the test as uint32_t result. The address of the variable is then passed to coreTest function (see the following example).
- 3. Define input variables to pass to coreTest:

```
A. uint8_t steps.
B. uint8_t forceFail.
C. uint32 t *result.
```

Example

```
#include "coreTest.h"
uint8_t steps=1;
```



```
uint32_t result=0;
uint8_t forceFail = 11;
void main
{
  coreTestInit(); //init index
/* Launch the core test function in order to perform Diagnosis SW*/
coreTest(steps, forceFail, &result);
if(result != 1) {
    errorHandler(); /*Fault handling*/
}
```

After the coreTest function returns, fault detection can be done by checking the result output value, as shown in the example above.

A complete example of the <code>coreTest</code> function, which calls all <code>testSegment</code> is provided in Appendix B - CPU Test Example.

3.3.2 Compiler Warnings

In Test Segment 17, two warnings are raised by the compiler at rows 278 and 286. They are related to the utilization of the stack pointer as the source register. The warnings come from the fact that the SP cannot assume an apriori well known value, since it strongly depends on the application. Therefore, its utilization could lead to unpredictable behavior.

However, this is not the case in this software, because, only the offset of the SP between two pre-defined assembly instruction blocks is used (accumulated in the signature). Since the offset value is fixed (this part of the code is critical, and exceptions are disabled in it), the software behavior is completely predictable.



3.3.3 Usage Conditions

The usage conditions are summarized in Table 3-6.

Table 3-6 Usage Conditions

ID	Торіс	Constraint	Description
1	Interrupt	Avoid corruption of function context	When interrupting the diagnostic software, the context of all general purpose registers, system register, including APSR and FPSCR, have to be saved and restored after returning from interrupt handling. See reference document [REF.1] for the CPU register definitions.
2	CPU mode	Correct execution of the software	Launch diagnostic software in privileged mode
3	Stack	Correct execution of the software	Use the main stack pointer as stack pointer for the function call
4	Environment	Avoid corruption of software flow by corruption of a control flow variable	Do not write to the testExcp variable
5	Diagnostic coverage	Execute all the coreTest steps during application software execution	If a subset of coreTest steps are executed from the CPU test, the overall diagnostic coverage of the CPU test is lower than the value achieved with the full CPU test
6	Interrupt	Avoid corruption of function context	The following condition applies if there is an Interrupt Service Routine making use of floating point instructions. Inside the application code, isolate in a critical section with interrupt disabled, the part of the code making use of floating point instructions.

3.4 **Define Directives for Software Configuration**

No specific define directives are needed.

3.5 Software Package Description

This section details how to identify the supplied software package, and also provides a description in a table format for each design file type.

3.5.1 Identification and Contents of Package

The software package version is:

- Revision 1.0.3
- File list.

Table 3-7 CPU Software Test Package and related MD5 signatures



File Name	MD5 Signature
closeTest.asm	1ceb60324c1b5653eddf9a0d25ef7732
coreTest.c	7b9bfb92fcf1b4d47c7ef21881e4bcc2
coreTest.h	647410b11f8c049c0a3c70341c75041f
globVar.h	61ebb216e6f98dc08c0fcbf906415b1e
initTest.asm	d72749c9df087a65ecab81f1339cc0af
testSegment00.asm	301aa75e0285956f86aa410336dbeb19
testSegment00.h	557784953af6d2b43298ba6e5e45fcc0
testSegment01.asm	4d67ea08005e8286be2030411cfb3e04
testSegment01.h	bd7f3370e24ff175e433e10d25d1df1d
testSegment02.asm	ff4dda0f01b651ccab65e47bd4a559a6
testSegment02.h	27d1a1efd77de1f3a5eca69ba2fcd943
testSegment03.asm	ee6fc066ca1c3bd8e46ba2c01e549474
testSegment03.h	b296d52facc6efc77fa21cf3ff8119f8
testSegment04.asm	5699c6d06fee35740b667e06de127ba0
testSegment04.h	7b82f6dd015b353bcb8b4e588aa2d32f
testSegment05.asm	57e2b5f11f330cc665ce9e726400aad5
testSegment05.h	e42445714f84d31fb8d4b514e4aa6261
testSegment06.asm	5f9466182f4a9584b287a7034b043b03
testSegment06.h	8ae790aa4e0683cc4cd669f619c4bb16
testSegment07.asm	8452bbb8cb22922495ca13dc4a24b06a
testSegment07.h	c5f204de84871bf84f5e9b89ddf49756
testSegment08.asm	a7e31d2abe88c211b48f012561d1585d
testSegment08.h	92604b9629d916e5f799629064e7a403
testSegment09.asm	ea87df5e3c11901354ccc608d215e1c8
testSegment09.h	853ee64ad838c6b0113ef765bc0a6834
testSegment10.asm	12580630c8f898575f7f4e7e7aeb0b9c
testSegment10.h	26a3caeda6473948dd4dccf700f7dc48
testSegment11.asm	c76a0b533e3ec1235106984ada374594
testSegment11.h	76525ecf711e921ab1aca21b0ba4a342
testSegment12.asm	8be38b28576b57b6db2f82ef7ff815a4
testSegment12.h	114f3bc90f5aefb4f7ae0d49201ce1e5
testSegment13.asm	e2fef8bf9cedbdf5ec40672aaea7df40
testSegment13.h	ebb9f7b5cfb596d6273235f4da271750
testSegment14.asm	1c3b02acef9a169bb9e1d79cd934e3d4
testSegment14.h	b0fe14f8fb2b794133c5fc4ce1d81a39
testSegment15.asm	383d4795095c07580ea12c10866961ea
testSegment15.h	9c0c62fec8cdc65372f0a45df62e009b
testSegment16.asm	0db83e3d411022658d012372c05b5369
testSegment16.h	1cdade74f94167841af65c2a96e1fbff
testSegment17.asm	58b2c69f33c4ef4aa78c139c03db1861
testSegment17.h	767a83085c8bfafa2ccfb65f7f448e48
testSegment18.asm	bd9f2f611659ab925a1e6f06a89bb0f5
testSegment18.h	7cdd0ed12725d2cf54623468629a54f0
	df47f17dfe4bda9dfbf20c61830f1e89
testSegment19.asm	



testSegment19.h	e0370a39dc267c37ccf1a0e58546d63c
testSegmentMgm.c	5e2072e0901c82b6fe5c0e856f1267ec
testSegmentMgm.h	b26103e3c01e14593793d28e93de1e2d

3.5.2 Description of design files Table 3-8 Design files

Table ID	File Name	Description
1	globVar.h	This file contains the compile option definitions, through which it is possible to select which TSs have to be included in the software. This file also contains the definition of the LUT, signature vector sizes, and other constants.
3	coreTest.h	This file contains the API of the diagnostic software. In particular, it contains the coreTest function declaration to be called by the application software.
4	coreTest.c	This file contains the definition of coreTest function
	testSegmentMgm.h	This file contains the API of the TS execution progress management. In particular, it contains the testSegmentMgm function declaration to be called by the coreTest function.
	testSegmentMgm.c	This file contains the definition of testSegmentMgm function
5	testSegmentxx.h with xx=0,,19	This file contains the declaration of the testSegment functions
7	<pre>testSegmentxx.as m with xx=0,,19</pre>	This file contains the assembler definition of the testSegment function
8	initTest.asm	This file contains the TS signature accumulation register initialization
9	closTest.asm	This file finalize the TS and state whether it is passed or not



3.6 Resources Usage

Resources related to the main file should not be part of the coreTest function, and should not be included.

The maximum stack usage is 212 bytes.

Note: No dynamic memory allocation is implemented.

Table 3-9 provides an overview of the memory resources used by the code.

Table 3-9 Memory resources

Module	ROM		RAM
	Code (bytes)	Data (bytes)	rw data (bytes)
coreTest.o	960	6704	0
testSegmentMgm.o	36	0	1
initTest.o	278	0	0
closeTest.o	28	0	0
testSegment00.0	1044	9	0
testSegment01.o	1962	0	0
testSegment02.0	844	0	0
testSegment03.0	2120	0	0
testSegment04.o	1838	0	0
testSegment05.0	1656	0	0
testSegment06.0	1908	0	0
testSegment07.o	604	0	0
testSegment08.0	2398	0	0
testSegment09.0	188	0	0
testSegment10.0	1340	0	0
testSegment11.0	2136	0	0
testSegment12.0	6320	0	0
testSegment13.0	976	0	0
testSegment14.0	2056	0	0
testSegment15.0	1642	0	0
testSegment16.0	3908	0	0
testSegment17.0	9254	0	0
testSegment18.0	1266	0	0
testSegment19.0	1578	0	0
Total (bytes)	46340	6713	1



Table 3-10 details the execution time for each testSegment for all valid values of dataSet. Interrupt disable time is also reported when applicable.

Table 3-10 Execution time

testSegment	dataSet	Execution time [clock cycles]	Execution time with 240 MHz clock [µs]	Maximum interrupt Disable Time [clock cycles]	Maximum interrupt Disable Time with 240 MHz clock [µs]
testSegment00		686	2,86	0	0
testSegment01		816	3,4	0	0
testSegment02		528	2,2	0	0
testSegment03	Float32_MUL_set0	2630	11,0	49	0,204
testSegment03	Int32_MUL_set0	2604	10,9	49	0,204
testSegment03	Int32_MUL_set1	2610	10,9	49	0,204
testSegment03	Int32_MUL_set2	2522	10,5	49	0,204
testSegment04	Float32_ADD_set0	4508	18,8	48	0,2
testSegment04	Int32_ADD_set0	2106	8,78	48	0,2
testSegment04	Int32_ADD_set1	2106	8,78	48	0,2
testSegment04	Int32_ADD_set2	2112	8,80	48	0,2
testSegment05	Float32_DIV_set0	2640	11	62	0,258
testSegment06		794	3,31	35	0,146
testSegment07		514	2,14	23	0,096
testSegment08	Int32_MUL_set0	1706	7,11	0	0
testSegment08	Int32_MUL_set1	1736	7,23	0	0
testSegment08	Int32_MUL_set2	1682	7,01	0	0
testSegment09	Int32_DIV_set0	1394	5,81	0	0
testSegment09	Int32_DIV_set1	1096	4,57	0	0
testSegment09	Int32_DIV_set2	1230	5,13	0	0
testSegment10		822	3,43	0	0
testSegment11		1086	4,52	52	0,216
testSegment12		4250	17,7	56	0,233
testSegment13	Int32_UMUL_set0	1494	6,23	0	0
testSegment14		1016	4,23	43	
testSegment15		752	3,13	0	0
testSegment16	Int32_ADD_set0	2296	9,57	0	0
testSegment16	Int32_ADD_set1	2316	9,65	0	0
testSegment16	Int32_ADD_set2	2074	8,64	0	0
testSegment17		3020	12,6	27	0,112
testSegment18		652	2,72	0	0
testSegment19		3556	44.0	46	0,191
Total	Float32_SQRT_set0	59354	14,8 247,45	732	3,04

3.7 **Requirements for Safety Relevant Applications**

Table 3-11 lists requirements for usage in safety relevant applications.

Table 3-11	Safety	relevant	requirements
------------	--------	----------	--------------

ID	Торіс	Sub-topic	Description
SW_1	SW integration	Function return	On the return of coreTest, evaluate the correctness of the execution by checking the value of the "result"
SW_2	SW integration	Function call	When calling the coreTest function more than once, take care to use different variables to store the outcome of the function, specifically the test result. In case the same variable is used, consider initializing it to zero before executing subsequent runs of the function.
SW_3	SW integration	Function environment	Before calling coreTest, initialize to 0 the variable used by the function to return the result value.
PR_1	Project management	User expertise	The user has to have good expertise in embedded programming on the target MCU HW Synergy S7 series. Expertise on assembly programming and C level/assembly interface is needed.

3.8 **Diagnostic Fault Coverage and Watch Dog Usage**

The diagnostic coverage provided by the CPU software test considers that all testSegments of type Fixed are launched together with all testSegments of type LUT, each one called with all the supported values of the parameter dataSet, as detailed in Table 3-2.

In addition, the coverage considers the contribution of a Watchdog. The use of the CPU software test should be integrated with the use of a Watchdog. Table 3-12 outlines the recommendations for its usage.

A Watchdog needs to be integrated due to the fact that some hardware faults prevent following the control flow of the software and, in such conditions, the presence of a Watchdog effectively detects such deviations.

Also, the CPU software test embeds some control flow mechanisms which are required to trigger the activation of such faults. However, as stated above, the fault detection needs the presence of a Watchdog.

Table 3-12 Recommendations on Watche	log usage
--------------------------------------	-----------

ID	Topic	Description	Comment
1	WD refresh	Consider a control flow monitoring for the WD refresh function. The refresh is done only if the control flow mechanism, for example, proper value of the global variable, is not respected.	
2	WD refresh	Consider the following strategy: Activate the WD refresh only if all the main tasks of the application software that have a predictable and periodic timing schedule are called in the proper order.	

4. RAM Software Test

4.1 **Test Objectives**

The objective of the RAM software test is to verify the embedded RAM memory of the MCU.

The main features of the software tests are as follows:

- 1. Whole memory check including stack(s).
 - Memory size programmable at compile time.
- 2. Block-wise implementation of the test.
 - Size of the block programmable at compile time.
- 3. Two test algorithm support
 - Extended March C-



— WALPAT.

- 4. Word-wise implementation of the test algorithms, where the elementary cell under test is considered to be of 32-bit width.
- 5. Support for destructive and non-destructive memory testing.

Information regarding test algorithms is provided in Appendix B - CPU Test Example.

4.2 Test Strategy

The scope of the RAM software test is to provide coverage across the whole embedded RAM, adopting a block-wise strategy.

The memory size and the block size are parameters that the user can select based on the device and its application needs, described as follows:

• MUTSize

This is the size of the memory under test, expressed in number of double words.

- BUTSize This is the size of the block under test, in terms of number of double words.
- numberOfBUT

This is the number of blocks in to which the memory is divided.



Figure 4-1: RAM block division.



Figure 4-1shows how the memory is divided into a number of blocks equal to numberOfBUT.

Each block is then identified with an index ranging from 0 to (numberOfBUT -1).

Each block can be tested in a destructive or non-destructive manner.

In order to support non-destructive testing, one block of the RAM is used as a buffer to store the content of the block under test. The buffer can be tested as well and this can be done with a destructive strategy before testing the other blocks.

A memory reserved area has to be defined for the buffer in order to preserve the integrity of the application software after running the test.

To do this:

1. Define the start address of the buffer.

This can be done by assigning the label addressBuffer inside the file testRAM.inc. See section 4.4 for a usage example.

2. Define IAR linker commands to reserve the memory buffer locations. Example of linker commands are provided in see section 4.4.

The code stores the result of the test in two unused RAM locations accessible from the application software by using two variables: resultTestRam1 and resultTestRam2 (see Figure 4-1).

The result variables are located at fixed absolute addresses, and they have to be placed into two different blocks.

This strategy has been selected to avoid not detecting a faulty block because the result itself is stored in the same faulty block.

Note: These two variables are initialized each time the RAM test function is called, and the user needs to check their values only after having called the RAM test function.

Allowing two copies of the test result to be stored into two different blocks makes fault detection possible because at least one variable is not stored inside a faulty block.

The location of the result variables can be fixed inside testRAM.h.

The application level user then has to check the values of the result variable after the test is completed.

Coding of the test result is as follows:

1. resultTestRam1= resultTestRam2=1 implies the test is passed.

 $2.\ \mbox{any other combinations means the test failed}.$

An example of a test result check, in addition to definition of addresses for the result variables, is provided in section 4.4.

4.3 API and RAM Test Environment

A RAM block test is called through a main interface function, testRAM. The testRAM function signature is defined as follows:

void testRAM(unsigned int index, unsigned int selectAlgorithm, unsigned int destructive)

testRAM interface in Table 4-1 describes the function interface in more detail.



Table 4-1 testRAM interface

Table ID	Parameter type	C type	Name	Description
1	Input	unsigned int	index	Specify the RAM block under test, from 0 to numberOfBUT-1
2	Input	unsigned int	selectAlgorithm	 Specify the algorithm to be run on the RAM block under test: 0 runs Extended March C-algorithm 1 runs WALPAT. Other values produce an error return value (that is, resultTestRam1 = resultTestRam2 = 0).
3	Input	unsigned int	destructive	 Specify the kind of test: 0 means non-destructive test is run, and RAM block content is saved in the buffer 1 means destructive test is run. Once a memory block is tested with a destructive procedure, its content is initialized with all zeros.

As specified in Table 4-1, index indicates the specific RAM block to be tested using the algorithm specified by selectAlgorithm. Each RAM block has a size in terms of double words, defined by BUTSize.

Valid values of index range between 0 and numberOfBUT-1.

numberOfBUT indicates the number of blocks in which the RAM is divided, and it is obtained by dividing the memory size by the size of the block specified by the BUTSize parameter.

Calling the function with an invalid value of the block index that is greater than (numberOfBUT-1), results in the return variables being set to 0, indicating a failed test.

4.4 **Software Integration Rules**

This section provides guidelines for how to integrate the RAM test software within the user project.

4.4.1 Code integration

Defining memory size and block size

The user has to set the size of the RAM under test and the size of each of the blocks.

This information has to be provided by the directives present in testRAM.h.

BUTSize can have one of the values shown in Table 4-2.

Table 4-2 Relation between BUTSize and MUTSize

BUTSize	Number of Blocks	Index
MUTSize/4	4	0, 1, 2, 3
MUTSize/8	8	0, 1, 2, 3, 4, 5, 6, 7
MUTSize/16	16	0, 1, 2, 3, 4,, 15
MUTSize/32	32	0, 1, 2, 3, 4,, 31
MUTSize/64	64	0, 1, 2, 3, 4,, 63
MUTSize/MUTSize	MUTSize	0, 1, 2, 3, 4,, MUTSize-1

Following is a working example for a 640 KB RAM, divided in blocks of 64 KB size each.



//size of the RAM Memory Under Test: 640KB = 640 * 1024 bytes = 655360 bytes =
163840double words
#define MUTSize 163840
//size of the Block of RAM Under Test of 64KB

#define BUTSize (MUTSize/10)

Reserving and placing the buffer

In case the user wants to perform non-destructive tests, it is needed a buffer memory area.

A buffer area can be reserved using the IAR linker configuration file (.icf file) and defining a variable *buffer* in the application code.

Assuming that the buffer size has to be 64 KB (specify 1024 bytes in hexadecimal format 0x10000) and the starting address of the buffer block is 0x20030000, add the following two instructions:

//RAM TEST:BufferStorage definition

1. define block BufferStorage with alignment = 1, size = 0x10000 { };

2. place at address mem:0x20030000 { block BufferStorage };

In the file *testRAM.inc* make sure to align the labels *addressBuffer_t* and *addressBuffer_w* to the buffer address, in particular to the most four significant address bytes and the least four significant address bytes.

addressBuffer_w EQU 0x0000

addressBuffer_t EQU 0x2003

Please note that the RAM buffer shall be stored within the SRAM memory dedicated address range which is specified in the HW manual [REF.2]

In addition, in order to minimize possible interference with the application SW, it is recommended to define a variable buffer in the application SW as a global variable and use it to force the allocation through the linker. Below is an example for the case reported above:

volatile unsigned int buffer[BUTSize]@ 0x20030000 = {0};

The user could then instruct the compiler to allocate the buffer to this variable, using for example the following instruction:

buffer[0] = 0;

Placing result variables

The software stores the result of the test in two unused RAM locations that are accessible from the application code by using two variables (resultTestRam1 and resultTestRam2).

These two variables have to be placed at two absolute addresses of the RAM.

Declaration of these two variables is defined in testRAM. h file.

The following is an example with 640 KB RAM divided in blocks of 64 KB each:

- resultTestRam1 is placed in the last double word location of the block 3
- resultTestRam2 is placed in the last double word location of the block 4.

The code in testRAM.c file is:

- unsigned int resultTestRam1 @ 0x20000000 = (unsigned int) 0;
- unsigned int resultTestRam2 @ 0x20010000 = (unsigned int) 0;.

Word length

The chosen RAM algorithm runs using a 32-bit word length.



Test flow and checking test results

It is recommended to initially run a destructive test on the buffer. The buffer test has the same result if it is run as destructive or non- destructive, and its content are lost.

A recommended flow for the RAM test is as follows:

- 1. Run testRAM function on the buffer block.
- 2. Run testRAM function on the other blocks of the RAM.

Consider the following instructions to effectively use the testRAM function:

1. Include testRAM.h.

2. Define input variables for parameters to call testRAM:

```
A. index.B. select Algorithm.C. destructive.
```

- 3. Call testRAM.
- 4. Check result variables.

Working example

```
#include "testRAM".h"
```

```
unsigned int index = 7<sup>1</sup>;
unsigned int selectAlgorithm = 0;
unsigned int destructive = 0;
```

```
testRAM(index, selectAlgorithm, destructive);
```

```
if(!(resultTestRam1&&resultTestRam2)){ /*Fault detection*/
    errorHandler();
```

}

After the testRAM function returns, a fault can be detected by checking the output value, as shown in the example above.

The output of testRAM is stored in two locations. So, if resultTestRam1 and resultTestRam2 are both equal to 1, no faults are detected. Otherwise, the fault handling management should start (calling of errorHandler() function in the above example).



¹ Not algorithm specific value. Only used as an example.

4.4.2 Usage Conditions

Table 4-3 summarizes usage conditions.

Table 4-3 Usage conditions

ID	Торіс	Constraint	Description
1	Interrupt	Avoid corruption of function context	When interrupting the RAM software test, the context of all general purpose registers, system register, including PSR and FAULTMASK, have to be saved and restored when returning from interrupt handling.
			See reference document [REF.1] for the detailed CPU register definitions.
2	CPU mode	Correct execution of the SW	Launch RAM software test in privileged mode
3	Stack	Avoid corruption of the stack	Test RAM blocks corresponding to stack locations in a non- destructive manner
4	Environment	Avoid corruption of variables used to check test results	In any application code other than the software test, do not overwrite values of resultTestRam1 and resultTestRam2 variables
5	Environment	Avoid data lost	The data saved by the application inside the buffer is lost when calling the RAM test
6	Configuration	Avoid data lost	Do not place the result variables (resultTestRam1 and resultTestRam2) in the same block as the buffer
7	Configuration	Compliance with SW test strategy	The minimum number of blocks into which the RAM is divided has to be 4
8	Configuration	Compliance with SW test strategy	Range of addresses of the memory under test has to be double word aligned
9	Configuration	Compliance with SW test strategy	For BUTSize, use the following formula: BUTSize=MUTSize/2 ^x with 1 <x<=log<sub>2(MUTSize)</x<=log<sub>
10	Configuration	n Compliance with SW Place resultTestRam1 and resultTestRam2 varia test strategy two different blocks of the RAM	
11	Diagnostic coverage	Use sufficient block size to guarantee diagnostic coverage value	Both RAM tests give medium coverage (90%) for permanent faults. This coverage value is valid under the condition that, for both tests, the minimum block size chosen for the test is not lower than 512 bytes.

4.5 **Define Directives for Software Configuration**

Before compiling the code, it is necessary to define the size of the RAM under test, the size of the blocks into which the memory is divided, and the word length for the executed RAM test algorithm.

All this information is specified by the directives described in Table 4-4.

Table 4-4 Define directives

Directives	Description		
MUTSize	Indicate the size of the RAM under test. The value associated with it expresses the size of the RAM in terms of double words.		
	This setting has to be in testRAM.h.		
BUTSize	Indicate the size of the blocks in which the RAM is divided. Value assigned to it has to be of the following type: MUTSize/4; MUTSize/8; MUTSize/16; MUTSize/32;; MUTSize/MUTSize		
	This value is always in terms of double words. This setting has to be in testRAM.h.		



4.6 **Software Package Description**

This section details how to identify the supplied software package, including its MD5 signature, and also provides a description in table format for each design file type.

4.6.1 Identification and Contents of Package

The software package version is identified as follows:

- Revision 1.0.1
- File list.

Table 4-5 RAM package and related MD5 signatures

File Name	MD5 Signature
extendedMarchCminus.asm	8d29d2c4ef1b516ace04e7403b986d5d
extendedMarchCminus.h	cf8ad143080603ae2aed9beeec3dfb64
testRAM.c	242961ce5f3ca457811f9797d15dab02
testRAM.h	03afee8c63ff96e4d3a3c8acecb3f42d
testRAM.inc	dc4cb561dc5fc9a154917b5d271ff418
walpat.asm	656312c044114043de5d6bf8904f8e0c
walpat.h	caf2c03440ea9f2ce8d2be2b7cc7894c

4.6.2 Description of design files

Table 4-6 Design files

Table ID	File Name	Description
1	testRAM.h	This file contains the API of the RAM test. In particular, it contains the testRAM function declaration to be called by the application software. It also contains the declaration of the result variables placed at fixed absolute addresses, and define directives.
2	testRAM.c	This file contains the definition of the testRAM function
3	extendedMarchCminus.h	This file contains the declaration of the Extended March C- algorithm function
4	extendedMarchCminus.a sm	This file contains the definition of the Extended March C- algorithm function
5	walpat.h	This file contains the declaration of the WALPAT algorithm function
6	walpat.asm	This file contains the definition of the WALPAT algorithm function
7	testRAM.inc	This file contains the definition of the patterns for the test execution



4.7 Resources Usage

Table 4-7 provides an overview of the memory resources used by the code.

The maximum stack usage is 60 bytes.

Table 4-7 Memory resources

Module	ROM	RAM (bytes)	
	Code (bytes)	Data (bytes)	
extendedMarchCminus.o	468	0	0
testRAM.o	124	0	8
walpat.o	468	0	0
Total (bytes)	1060	0	8

The timing performance details in Table 4-8, are referenced to the test of one 1 Kb RAM block.

Table 4-8 Execution time

Algorithm	Non-destructive execution time [clock cycles]	Non-destructive execution time with 240 MHz clock [µs]	Destructive execution time [clock cycles]	Destructive execution time with 240 MHz clock [µs]
Extended March C-	104106	433	100524	418,85
WALPAT	8699562	36248	8695982	36233,26

4.8 **Requirements for Safety Relevant Applications**

Table 4-9 lists the recommendations for usage in safety relevant applications.

Table 4-9 Safety relevant requirements

ID	Торіс	Sub-topic	Description
RAM_SW_1	Test flow	Buffer	Before testing blocks other than the buffer, perform destructive testing on the buffer. This should be done to avoid corruption of the test result because of a faulty buffer.
RAM_SW_2	Configuration	Number of blocks	Consider dividing the memory under test into a minimum number of blocks, possibly equal to 4. This is to properly detect address faults. The larger the block, more efficient the address fault detection.

5. ROM Software Test

5.1 Test Objectives

The objective of the ROM software test is to verify the embedded ROM memory of the MCU.

The main features of the software tests are as follows:

- Whole memory check
- Possibility to test with a block-wise strategy, generating multiple CRC signatures
- Support for three CRC polynomials
- Support for incremental mode calculation, that is, calculation of the CRC signature can be time-wise split.

5.2 **Test Strategy**

The scope of the ROM software test is to verify the embedded ROM using a CRC technique. Error detection is achieved as follows:

- 1. A range of ROM addresses is chosen. This step defines the block under test.
- 2. A reference checksum value is calculated using the IAR linker and saved inside the memory.



- 3. During the ROM software test execution, the hardware peripheral CRC calculator (see reference document [REF.2] for the peripheral details) is used to produce an actual checksum value of the ROM under test in order to check its integrity.
- 4. The calculated checksum value is compared with that stored in memory, and an error is detected if the two values do not match.
- 5. The previous steps are repeated for a different block of memory until the whole ROM area is covered.

5.2.1 Checksum Generation using the IAR linker

Before compiling the ROM software test, checksum generation by the IAR linker has to be enabled.

In addition, use the following steps:

- 1. Place a checksum variable for each ROM addresses range under test.
- 2. Start and end addresses of the ROM without considering the location in which checksum value is placed.
- 3. Consider the size and alignment of the checksum variable.
- 4. Consider the initial value of the checksum variable.
- 5. Consider the checksum algorithm used (chosen polynomial).
- 6. Consider the checksum variable bit order.

Further details are provided in section 5.5.

5.2.2 MCU CRC Peripheral

The CRC calculator generates CRC codes for data blocks. For details on the peripherals, see document reference [REF.2]. It provides the use of any of the three polynomials listed as follows:

- 8-bit CRC
- $x^8 + x^2 + x + 1$
- 16-bit CRC
 x¹⁶+x¹⁵+x²+1

 $- x^{16} + x^{12} + x^5 + 1.$

5.3 **Top Level Software Structure**

The following two functions are used to run the CRC calculator module and generate the checksum value:

- crcHwSetup enables the CRC HW module and configures the control registers to select the selected CRC polynomial to be used
- crcComputation calculates checksum on all the bytes of the selected ROM block.

5.3.1 ROM Test APIs

The function signatures are as follows:

void crcHwSetup(unsigned int crc)

```
uint16_t crcComputation(unsigned int checksumBegin, unsigned int checksumEnd,
unsigned int incrMode)
```

Table 5-1 describes more details of the interface to the functions.



Table 5-1 ROM test APIs

Table ID	Function	Parameter type	C type	Name	Description
1	crcHwSetup	input	unsigned int	crc	Specify the kind of CRC generating polynomial: -0: x^8+x^2+x+1 (8-bit CRC) -1: $x^{16}+x^{15}+x^2+1$ (16-bit CRC) -2: $x^{16}+x^{12}+x^5+1$ (16-bit CRC) -Other values: default is 16-bit CRC $x^{16}+x^{15}+x^2+1$
2	crcComputation	input	unsigned int	checksumBegin	Specify ROM block start address
3	crcComputation	input	unsigned int	checksumEnd	Specify ROM block end address
4	crcComputation	input	unsigned int	incrMode	Specify the CRC calculation mode: -0: incremental mode not active - Other values: incremental mode active.
5	crcComputation	output	uint16_t	-	The return value of the function is the computed checksum value

Note: Within the crcComputation function:

- The CRC signature is initialized to 0xff in case of CRC_8 utilization or 0xffff in case of CRC_16, or CRC_16_CCITT
- The return value is th' 1's complement of the calculated checksum.
- Note: The block size of the memory for the CRC calculation is defined by the difference between the end and the start addresses, and it has to be a multiple of the CRC length.

5.3.2 Incremental mode calculation

The input parameter incrMode allows the user to split the calculation of the CRC signature for the same ROM block as best suited to the requirements of its application.

The behavior, as summarized in Figure 5-1 is as follows:



- The ROM block for which the CRC is to be calculated is divided in sub-blocks identified by a given set of addresses (3 groups of addresses in the example)
- The crcComputation is then run on each set of addresses
- The first call of crcComputation is made with no incremental mode while the following calls need to have the incremental mode active in order to accumulate previous partial results
- After the last function call, the total block CRC is returned.



Figure 5-1: Incremental mode calculation.

5.4 Software Integration Rules

5.4.1 Code integration

To call the ROM test functions, use the following steps:

- 1. Include crc.h.
- 2. Define external variables for each CRC signatures generated by the IAR linker and placed in ROM.
 - 1. Define variable for input parameter of crcHwSetuA.crcType.
- 3. Define variables for input parameter of crcComputation:

A. checksumBegin.

- B. checksumEnd.
- C. incrMode.
- 4. Define output variable in order to store the result of the crcComputation.

Refer to the example in section 5.4.2, which explains a case in which two ROM address ranges are tested.

5.4.2 Test flow and test result check

The recommended test flow is as follows:

- 1. Initialize the peripheral using crcHwSetup.
- 2. Evaluate the checksum using crcComputation.
- 3. Compare with the expected checksum for error detection.

Working example

```
#include "crc.h"
extern const uint16_t __checksum;
unsigned int type = 1;
crcHwSetup(type);
unsigned int checksumStart = 0x00000000;
unsigned int checksumStop = 0x003FFFFB;
unsigned int crcIncr = 0;
```



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```
uint16_t crcResult;
crcResult = crcComputation(checksumStart, checksumStop, crcIncr);
if(crcResult != __checksum) {
    errorHandler();
}
```

After the crcComputation function returns, a fault can be detected by checking the output value as shown in the example above. The crcResult achieved by the ROM software test is compared with ______ checksum, which is the reference value computed by the IAR linker.

Working example with incremental mode

```
#include "crc.h"
extern const uint16_t _checksum;
unsigned int type;
unsigned int checksumStart;
unsigned int checksumStop;
uint16 t crcResult;
unsigned int crcIncr;
  type = 1;
  crcHwSetup(type);
  crcIncr = 0;
  checksumStart = 0x0000000;
                                           //1MB
  checksumStop = 0x000FFFFB;
  crcResult = crcComputation(checksumStart, checksumStop, crcIncr);
  crcIncr = 1;
  checksumStart = 0x00100000;
  checksumStop = 0x001FFFFB;
                                            //1MB
  crcResult = crcComputation(checksumStart, checksumStop, crcIncr);
  crcIncr = 1;
  checksumStart = 0x00200000;
  checksumStop = 0x002FFFFB;
                                            //1MB
  crcResult = crcComputation(checksumStart, checksumStop, crcIncr);
  crcIncr = 1;
  checksumStart = 0x00300000;
  checksumStop = 0x003FFFFB;
                                           //1MB
  crcResult = crcComputation(checksumStart, checksumStop, crcIncr);
```



```
if(crcResult != __checksum){
    errorHandler();
}
```

The above example shows how the CRC for a 4 MB block can be calculated with 4 cumulated runs of the crcComputation function.

The above example also shows that the 4 calls of the crcComputation function are sequential. However, this is not a definitive requirement. The calls can be executed in a different order as long as the usage conditions described in section 5.4.3 are maintained.

5.4.3 Usage Conditions

Table 5-2 summarizes usage conditions.

Table 5-2 Usage conditions

ID	Торіс	Constraint	Description
1	Interrupt	Avoid corruption of function context	When interrupting the ROM software test, the context of all general purpose registers, system register, including PSR and FAULTMASK, have to be saved and restored after returning from interrupt handling.
			See reference document [REF.1] for the CPU register definitions.
2	Incremental mode	Avoid corruption of the calculated CRC value	When the incremental mode is used, do not change the setting or use the HW peripheral CRC calculator until the CRC calculation is completed. This is valid for any kind of software such as application software or any interrupt handlers.

5.5 Checksum Generation Using IAR Tools

The ROM test requires a reference checksum for each address range under test. The reference checksum is necessary for comparison with that computed by the CRC calculator.

To ensure accurate control of the error detection performance of the code, it may be necessary to generate multiple checksums.

This section shows how to use the IAR Embedded Workbench for ARM version 8.23.1.17132 to generate the checksum.

The steps are as follows:

- 1. Provide information to the IAR linker as to where to place checksum values. Also, provide information about the symbols for the start and end addresses of the ROM blocks under test.
- 2. Use the IAR graphic interface to perform the checksum calculation.
- 3. In the .icf file, define memory ranges where the checksum values should be placed.

The working example provided in the following section gives additional information on how to use the IAR tools to generate the required CRCs.

5.5.1 Example Checksum Generation with IAR Tools

Assume that the ROM test address range is 0x0000000 - 0x003 FFFFF, and a checksum is required to be generated using the polynomial $x^{16}+x^{12}+x^{5}+1$ (16-bit CRC-16CCITT).

Use the following steps:

1. Go to **Project > OptiI... > Linker > Checksum** and set the following parameters:



Note: The crcResult is compared with the value computed by the IAR linker only after the last call of the crcComputation function.

A. Select **Fill unused code memory** option.

- B. File pattern = 0x00.
- C. Start Address = 0x00000000.
- D. End address = 0x003FFFFB.
- E. Select Generate checksum option.
- F. Checksum size = 2 bytes.
- G. Alignment = 1.
- H. Algorithm = CRC polynomial, 0x1021.
- I. Bit order = MSB.
- J. Initial value = 0xFFFF.
- K. Checksum unit size = 8 bit.
- 2. In the .icf file, define memory ranges and locations of the checksums.

```
define symbol __ICFEDIT_region_ROMuT_start__ = 0x00000000;
define symbol __ICFEDIT_region_ROMuT_end__ = 0x003FFFFF;
define region CHECKSUM_region = mem:[from __ICFEDIT_region_ROMuT_start__ to
__ICFEDIT_region_ROMuT_end__];
```

place at end of CHECKSUM_region { ro section .checksum };

Options for node "S7_b	link_e2s_connect_s7" X
Category: General Options Static Analysis	Factory Settings
Runtime Checking C/C++ Compiler Assembler	Config Library Input Optimizations Advanced Output List
Output Converter Custom Build	Fill unused code memory
Build Actions	Fill pattem: 0x00
Linker Debugger	Start address: 0x00000000 End address: 0x003FFFFB
Simulator	Generate checksum
Angel CMSIS DAP	Checksum size: 2 bytes V Alignment: 1
GDB Server	Algorithm: CRC polynomia V 0x1021
IAR ROM-monitor I-jet/JTAGjet	Result in full size
J-Link/J-Trace	Complement: 1's complement V 0xFFFF
TI Stellaris Macraigor	Bit order: MSB first V Use as input
PE micro	Reverse byte order within word
RDI ST-LINK	Checksum unit size: 8-bit ~
Third-Party Driver	OK Cancel

Figure 5-2: IAR environment options.

For more information about these commands, refer to reference document [REF.3].

5.6 Software Package Description

This section details how to identify the supplied software package, and also provides a description in table format for each design file type.

5.6.1 Identification and contents of package

The software package version is as follows:



- Revision 1.0.1
- File list.

Table 5-3 ROM Package and related MD5 signatures

File Name	MD5 Signature
6. crc.c	66d4c9c03eb5906ce5364f5d8b804858
crc.h	2d5cdb92e1acaf76bb3d5dd5f4c90c48
S7G2_registers.h	4a2dfba75ed595991e87d34b4fb4db74

6.1.1 Description of Design Files

Table 5-4 Design files

Table ID	File Name	Description
	crc.h	This file contains the declaration of the two functions for the crc calculator:
		• crcHwSetup: Initializes CRC module
1		 crcComputation: Runs CRC on the specified ROM block.
	crc.c	This file contains the definition of the two functions declared in the file
2		crc.h.
3	S7G2_registers.h	This file contains the definitions of the needed peripheral registers.

6.2 **Resources Usage**

Table 5-5 provides an overview of the memory resources used by the code.

The maximum stack usage is 0 bytes.

Table 5-5 Memory resources

Module	R	RAM (bytes)	
	Code (bytes)	Data (bytes)	
crc.o	232	0	4
Total (bytes)	232	0	4

Table 5-6 shows the execution time for calculating a CRC using the polynomial $x^{16}+x^{15}+x^2+1$ with a block size of 4 Kb.

Table 5-6 Execution time

Function	Execution time for a ROM block size of 4 Kb (clock cycles)	Execution time for a ROM block of 4 Kb at 240 MHz clock (μs)
crcComputation	57434	239

6.3 **Requirements for Safety Relevant Applications**

Table 5-7 lists recommendations for usage in safety relevant applications.

Table 5-7 Safety relevant requirements

ID	Торіс	Sub-topic	Description
ROM_SW_1	CRC type	-	Adopt the following CRC16 polynomial x ¹⁶ +x ¹⁵ +x ² +1
ROM_SW_2	Block length	-	Use a block size of 4 KB

Using the above mentioned recommendations, it is possible to detect all single-bit and double-bit corruptions within one block.



In addition, regardless of the block size, the use of such a polynomial allows for the detection of an odd number of single bit errors, with the following performance in relation to burst error detection, where a burst of length k corresponds to the presence of k consecutive corrupted bits:

- All bursts with length equal and less than 16 bits
- 99.997 percent of bursts of 17 bits
- 99.998 percent of bursts with length greater than 18 bits.

7. CAC Configuration Software

7.1 Test Objectives

The objective of the CAC configuration software is to configure the CAC. For safety applications, this software is used to:

- Select PCLKB as the measurement target clock for the CAC
- Select the sub-clock oscillator as a measurement reference clock for the CAC.

This configuration allows the detection of deviations of the main clock oscillator and PLL due to systematic or random hardware failures.

The CAC configuration software also enables the Synergy S7 oscillation stop detection circuit functionality. In case the main clock stops, this circuit is in charge of switching to the middle-speed on-chip oscillator, and generating an NMI interrupt.

7.2 Test Strategy

The test strategy is to configure the CAC peripheral to monitor the PCLKB clock using the sub-clock oscillator.

If the frequency of the monitored clock deviates from a configured range during runtime, two types of interrupts can be generated, namely a frequency error interrupt, or an overflow interrupt. The user of this module must enable these two kinds of interrupts and handle them.

Note: The user must enable the sub-clock oscillator through the SOSCCR register (that is, SOSCCR.SOSTP = 0b. See document reference [REF.2]). Otherwise, the monitoring will not work.

The allowed frequency range is evaluated according to the following equations:

CAULVR (upper limit value) can be computed by rounding down the result from the following equation and converting it into a hexadecimal value:

$$CAULVR = floor\left(\frac{\frac{PCLKB}{CLKT_{DIV}} * \left(1 + 1 - \frac{DC}{100}\right)}{\frac{CLK_{ref}}{CLKR_{DIV}}}\right)$$

CALLVR (lower limit value) can be computed by rounding up the result from the following equation and converting it into a hexadecimal value:

$$CALLVR = ceil\left(\frac{\frac{PCLKB}{CLKT_{DIV}} * \left(\frac{DC}{100}\right)}{\frac{CLK_{ref}}{CLKR_{DIV}}}\right)$$

The parameters are described in Table 7-1.



Table 7-1 Parameter description for CAULVR, CALLVR

Parameter	Description	Unit
PCLKB	Frequency of the peripheral module clock B	MHz
DC	Target diagnostic coverage. The user has to add a safety margin to the claimed DC, for example, 90% + 1% margin Renesas allows a DC range from, for example, 60 … 95%	%
CLK _{ref}	Frequency of the reference clock. This is based on the sub-clock oscillator frequency (32.768 kHz), considering the accuracy of the selected external crystal	MHz
CLKT _{DIV}	Division according to the Measurement Target Clock Frequency Division Ration Select (TCSS) register	-
CLKR _{DIV}	Division according to the Measurement Reference Clock Frequency Division Ration Select (RCDS) register	-

In addition to the CAC function, the Synergy S7 has an oscillation stop detection circuit. If the main clock stops, the middle-speed on-chip oscillator is automatically used instead, and an NMI interrupt is generated. The user of this module must handle the NMI interrupt and check the NMISR.OSTST bit.

7.3 CAC Configuration Software API

The function signatures are as follows:

void ClockMonitor_Init(double target_clock_frequency, target_clk_div_t target_clock_division,

reference clk div t reference clock division, double dc, CLOCK MONITOR ERROR CALL BACK CallBack);

Table 7-2 describes more details of the interface to the functions.

Table 7-2 CAC configuration software APIs

Table ID	Function	Parameter type	C type	Name	Description
1	ClockMonitor_ Init	Input	double	target_clock_frequ ency	The target clock frequency in Hz
2	ClockMonitor_ Init	Input	target_clk_div_t	<pre>target_clock_divis ion</pre>	The target clock division to be set
3	ClockMonitor_ Init	Input	reference_clk_div_t	reference_clock_di vision	The reference clock division to be set
4	ClockMonitor_ Init	Input	double	dc	The diagnostic coverage in percentage
5	ClockMonitor_ Init	Input	CLOCK_MONITOR_ ERROR_CALL_BAC K	CallBack	Function to be called if the main clock deviates from the allowable range

In reference to the formula parameters described in Table 7-1, the function parameters are mapped as follows:

- target clock frequency = PCLKB
- target clock division = CLKT_{DIV}
- reference clock division = CLKR_{DIV}
- dc = DC.

7.4 Software Integration Rules

This section provides guidelines on integrating the CAC configuration software within the user project.



7.4.1 Code integration

Follow the instructions below to call the CAC configuration software functions:

- 1. Include clock monitor.h.
- 2. Define variables for input parameters of ClockMonitor_Init:
 - A. target_clock_frequency.
 - $B. \ \texttt{target_clock_division}.$
 - $C. \ \texttt{reference_clock_division.}$
 - D. dc.
 - E. CallBack.

Refer to the example in section 7.4.2 on how to use the diagnostic software.

7.4.2 Usage Conditions

The monitoring of the PCLKB clock is set-up with a single function call to ClockMonitor_Init.

For example:

```
#define TARGET_CLOCK_FREQUENCY_HZ (60000000) // PCLKB: 60MHz
#define DC (90) // Diagnostic Coverage: 90%
target_clk_div_t target_div = TAR_DIV_4;
reference_clk_div_t ref_div = REF_DIV_32;
```

```
/*Enable Sub-Clock*/
PRCR_reg->PRCR = 0xA501;
SOSCCR_reg->SOSCCR_b.SOSTP = 0;
PRCR reg->PRCR = 0xA500;
```

```
ClockMonitor_Init(TARGET_CLOCK_FREQUENCY_HZ, target_div, ref_div, DC,
CAC_Error_Detected_Loop);
```

The hardware performs the clock monitoring, and so the software does not need to do anything during the periodic tests.

In order to enable interrupt generation by the CAC, both the Interrupt Controller Unit (ICU) and Cortex-M4 Nested Vectored Interrupt Controller (NVIC) should be configured.

For configuring the ICU, it is necessary to set the ICU Event Link Setting Register (IELSRn) to the event signal number corresponding to the CAC frequency error interrupt (CAC_FERRI = 0x87) and CAC overflow (CAC_OVFI = 0x89). In particular, it is necessary to configure one IELSR register so that it is linked to the previously mentioned CAC events:

IELSRn.IELS = 0x87; // (CAC_FERRI)
IELSRn.IELS = 0x89; // (CAC_OVFI)

In addition, in order to enable the Cortex-M4 NVIC to handle the CAC interrupts, the following instructions should be set:

```
NVIC_EnableIRQ(CAC_FREQUENCY_ERROR_IRQn);
NVIC EnableIRQ(CAC OVERFLOW IRQn);
```

```
where CAC FREQUENCY ERROR IRQn and CAC OVERFLOW IRQn are the IRQ number defined by the user<sup>2</sup>.
```

If oscillation stop is detected, an NMI interrupt is generated. User code must handle this NMI interrupt and check the NMISR.OSTST flag as shown in the following example:



² See Table 2-16 in reference document [1] for more details about IRQ numbers

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```
if(1 == R_ICU->NMISR_b.OSTST)
{
     Clock_Stop_Detection();
     /*Clear OSTST bit by writing 1 to NMICLR.OSTCLR bit*/
     R ICU->NMICLR b.OSTCLR = 1;
```

}

The OSTDCR.OSTDF status bit can then be read to determine the status of the main clock.

7.5 Define Directives for Software Configuration

No specific directives are present for CAC configuration software.

7.6 Software Package Description

This section details how to identify the supplied software package, including its MD5 signature, and also provides a description in a table format for each design file type.

7.6.1 Identification and Contents of Package

The software package version is listed as follows:

- Revision 1.0.2
- File list.

Table 7-3 CAC configuration software package and related MD5 signatures

File Name	MD5 Signature
clock_monitor.c	1bdc9c2713d2a51bfd38a9724bb0be85
clock_monitor.h	78f648e238cbbdbfeaefc94beaf5de89
S7G2 registers.h	ac539ac998214ac9cba73eeef86985fd

7.6.2 Description of Design Files

Table 7-4 Design files

Table ID	File Name	Description	
1	clock_monitor.h	This file contains the declaration of the ClockMonitor Init	
	_	function for monitoring initialization	
2	clock_monitor.c	This file contains the definition of clock monitor function	
3	S7G2_registers.h	This file contains the definitions of the needed peripheral	
		registers	

7.7 Resource Usage

Table 7-5 provides an overview of the memory resources used by the code.

Maximum stack usage is 152 bytes for both versions.

Table 7-5 Memory resources

Module	ROM		RAM (bytes)
	Code (bytes)	Data (bytes)	
clock_monitor.o	716	16	4
Total (bytes)	716	16	4


Table 7-6 illustrates the execution time.

Table 7-6 Execution time

Function	Clock Cycle Count	Time measured (μs) at 240 MHz
Clock_monitor	3105	12,94

7.8 **Requirements for Safety Relevant Applications**

Refer to the Safety Manual [REF.4].

8. IWDT Management Software

8.1 **Test Objectives**

A watchdog is used to detect abnormal program execution. If a program is not running as expected, the Watchdog is not refreshed by software as required, and so, detects an error.

8.2 Test Strategy

The Independent Watchdog Timer (IWDT) module of the Synergy S7 is used for this purpose. The IWDT includes a windowing feature where the refresh must happen within a specified window rather than just before a specified time. It can be configured to generate an internal reset or a NMI interrupt if an error is detected. All the configurations for IWDT can be done through the OFS0 register whose settings are controlled by the user (see section 8.4.2 for a configuration example). A function is provided to be used after a reset, to decide if the IWDT has caused the reset.

8.3 **IWDT Management Software APIs**

The function signatures are as follows:

void IWDT_Init (void) void IWDT_Kick (void) bool IWDT DidReset (void)

Table 8-1 describes more details of the interface to the functions.

Table 8-1 IWDT management software APIs

Table ID	Function	Parameter type	C type	Name	Description
1	IWDT_DidReset	output	bool	N/A	Returns true if the IWDT times out or is not refreshed correctly. This can be called after a reset, to decide if the Watchdog caused the reset.

8.4 Software Integration Rules

8.4.1 Code integration

The instructions to call the IWDT management software function are as follows:

1. Include iwdt.h.

2. Define a boolean variable for output of IWDT_DidReset.

Refer to the example in section 8.4.2, which explains how to use the diagnostic software.

8.4.2 Usage conditions

In order to configure the IWDT, it is necessary to set the OFS0 register correctly. The following code can be used to set the value that has to be stored at the OFS0 memory allocation (OFS0 address = 0x00000400).



```
/* IWDT Start Mode Select */
#define IWDTSTRT ENABLED (0x0000000)
#define IWDTSTRT DISABLED (0x0000001)
/*Time-Out Period selection*/
#define IWDT_TOP_128 (0x0000000)
#define IWDT_TOP_512 (0x00000001)
#define IWDT TOP 1024 (0x0000002)
#define IWDT TOP 2048 (0x0000003)
/*Clock selection. (IWDTCLK/x) */
#define IWDT_CKS_DIV 1 (0x0000000) // 0b0000
#define IWDT CKS DIV 16 (0x0000002) // 0b0010
#define IWDT CKS DIV 32 (0x0000003) // 0b0011
#define IWDT_CKS_DIV_64 (0x00000004) // 0b0100
#define IWDT_CKS_DIV_128 (0x000000F) // 0b1111
#define IWDT_CKS_DIV_256 (0x0000005) // 0b0101
/*Window start Position*/
#define IWDT_WINDOW_START_25 (0x0000000)
#define IWDT_WINDOW_START_50 (0x0000001)
#define IWDT_WINDOW_START_75 (0x0000002)
#define IWDT WINDOW START_NO_START (0x0000003) /*100%*/
/*Window end Position*/

        #define
        IWDT_WINDOW_END_75
        (0x0000000)

        #define
        IWDT_WINDOW_END_50
        (0x0000001)

        #define
        IWDT_WINDOW_END_25
        (0x0000002)

#define IWDT WINDOW END NO END (0x0000003) /*0%*/
/*Action when underflow or refresh error */
#define IWDT_ACTION_NMI (0x0000000)
#define IWDT_ACTION_RESET (0x00000001)
/*IWDT Stop Control*/
#define IWDTSTPCTL COUNTING CONTINUE (0x0000000)
#define IWDTSTPCTL COUNTING STOP (0x0000001)
#define BIT0 RESERVED (0x0000001)
#define BIT13 RESERVED (BIT0 RESERVED << 13)</pre>
#define BIT15 RESERVED (BIT0 RESERVED << 15)</pre>
#define OFS0 IWDT RESET MASK (0xFFFF0000)
/*This define is used to configure the iWDT peripheral*/
#define OFS0 IWDT CFG (BIT15 RESERVED | BIT13 RESERVED | BIT0 RESERVED |
(IWDTSTRT_ENABLED << 1) | (IWDT_TOP_1024 << 2) | (IWDT_CKS_DIV_1 << 4) |
(IWDT WINDOW END NO END << 8) | (IWDT_WINDOW_START_NO_START << 10) |
(IWDT ACTION RESET << 12) | (IWDTSTPCTL COUNTING CONTINUE << 14))
```

The value OFS0_IWDT__CFG is stored at the OFS0 address at compile time, in order to configure the IWDT. In particular, the example enables the IWDT setting a time-out period of 1024 clock cycles at IWDTCLK/1 clock frequency, also counting during the sleep mode of the microcontroller. The example does not set any start/end of the Watchdog window, or configure a reset in case of Watchdog expiration.

The IWDT should be initialized as soon as possible, following a reset with a call to IWDT_Init:

```
/*Setup the Independent WDT.*/
```



IWDT_Init();

Then, the watchdog must be refreshed regularly to stop the Watchdog from timing out and performing a reset. If using windowing, the refresh must not just be regular, but also timed to match the specified window. A Watchdog refresh is called as follows:

```
/*Regularly kick the watchdog to prevent it performing a reset. */
```

IWDT_Kick();

If the Watchdog has been configured to generate an NMI on error detection, then the user must handle the resulting interrupt.

If the Watchdog has been configured to perform a reset on error detection, then following a reset, the code should check if the IWDT caused the Watchdog reset by calling IWDT DidReset:

```
if(TRUE == IWDT_DidReset())
{
    /*todo: Handle a watchdog reset.*/
    while(1) {
        /*DO NOTHING*/
    }
```

}

8.5 **Define Directives for Software Configuration**

No specific directive are present for IWDT management software.

8.6 Software Package Description

This section details how to identify the supplied software package and also provides a description in table format for each design file type.

8.6.1 Identification and Contents of Package

The software package version is listed as follows:

- Revision 1.0.1
- File list.

Table 8-2 IWDT package and related MD5 signatures

File Name	MD5 Signature
iwdt.c	c1ff175e73414577ebed6545d137963f
iwdt.h	136b2dd867a8551137d6ab80a85f4230
S7G2_registers.h	b64c20dfea0a3d0667d8fcf86e154b2e



8.6.2 Description of design files Table 8-3 Design files

Table ID	File Name	Description
1	iwdt.h	 This file contains the declaration of the functions: IWDT_Init: Initializes the Independent Watchdog Timer. After calling this, the IWDT kick function must be called at the correct time to prevent a Watchdog error. If configured to produce an interrupt, then this will be the Non Maskable Interrupt (NMI). This must be handled by user code which must check the NMISR.IWDTST flag. IWDT_Kick: Refreshes the watchdog count IWDT_DidReset: Returns true if the IWDT has timed out or not been refreshed correctly. This can be called after a reset to decide if the Watchdog caused the reset.
2	iwdt.c	This file contains the definition of the two functions declared in the file iwdt.h.
3	S7G2_registers.h	This file contains the definitions of the needed peripheral registers

8.7 Resources Usage

Table 8-4 provides an overview of the memory resources used by the code.

Maximum stack usage is 0 bytes.

Table 8-4 Memory resources

Module	ROM	ROM RAM (b)		
	Code (bytes)	Data (bytes)		
iwdt.o	124	0	0	
Total (bytes)	124	0	0	

Table 8-5 illustrates the execution time for the specific functions.

Table 8-5 Execution time

Function	Clock cycles count	Time measured (μs) at 240 MHz
IWDT_Init	86	0,3
IWDT_Kick	80	0,3
IWDT_DidReset	96	0,4

8.8 **Requirements for Safety Relevant Applications**

Refer to the Safety Manual [REF.4].

9. LVD Configuration Software

9.1 Test Objectives

The Synergy S7 has a voltage detection circuit. This can be used to detect when the power supply voltage (Vcc) falls below a specified voltage.

9.2 Test Strategy

The supplied sample code demonstrates using Voltage Detection Circuit 1 to generate an NMI interrupt when Vcc falls below a specified level. The hardware is also capable of generating a reset, but this behavior is not supported in the sample code.



9.3 LVD Configuration Software APIs

The function signatures are as follows:

void VoltageMonitor_Init(VOLTAGE_MONITOR_LEVEL eVoltage)

Table 9-1 describes more details of the interface to the functions.

Table 9-1 LVD configuration software APIs

Table ID	Function	Parameter type	C type	Name	Description
1	VoltageMonitor _Init	Input	VOLTAGE_ MONITOR_ LEVEL	eVoltage	The specified low voltage level. See declaration of enumerated type VOLTAGE_MONITOR_LEVE L in voltage.h for details.

9.4 **Software Integration Rules**

9.4.1 Code integration

To call the LVD configuration software functions, use the following steps:

- 1. Include voltage.h.
- 2. Define variable for input parameter of VoltageMonitor_t:
 - 1. A. eVoltage

Refer to the example in section 9.4.2, which explains how to use the diagnostic software.

9.4.2 Usage conditions

The Voltage Detection Circuit is configured to monitor the main supply voltage with a call to the VoltageMonitor_Init function. This should be setup as soon as possible following a power on reset.

Please note to set the LVD1SR.DET bit to 0 both before calling VoltageMonitor_init function and in NMI routine, see Section 8.2.2 of [REF.2] for further details.

Please set a voltage threshold *eVoltage* lower than the Vcc nominal value.

The following example sets up the voltage monitor to generate an NMI if the voltage drops below 2.99V.

```
VoltageMonitor Init (VOLTAGE MONITOR LEVEL 2 99);
```

If a low voltage condition is detected, an NMI interrupt is generated that the user must handle:

```
/*Low Voltage LVD1*/
if(1 == R_ICU->NMISR_b.LVD1ST)
{
     Voltage_Test_Failure();
     /*Clear LVD1ST bit by writing 1 to NMICLR.LVD1CLR bit*/
     R_ICU->NMICLR_b.LVD1CLR = 1;
}
```

9.5 **Define Directives for Software Configuration**

No specific directives are present for LVD configuration software.

9.6 Software Package Description

This section details how to identify the supplied software package and also provides a description in table format for each design file type.



9.6.1 Identification and Contents of Package

The software package version is listed as follows:

- Revision 1.0.1
- File list.

Table 9-2 LVD package and related MD5 signatures

File Name	MD5 Signature
S7G2_registers.h	b64c20dfea0a3d0667d8fcf86e154b2e
voltage.c	15e89e618e92fe6f2fb89bd995a820a8
voltage.h	072694c1d415b5bab51acc4464dff5b8

9.6.2 Description of design files

Table 9-3 Design files

Table ID	File Name	Description
1	voltage.h	This file contains the declaration of the functions for voltage monitor:
		 Bullet list item
2	voltage.c	This file contains the definition of the two functions declared in the file voltage.h.
3	S7G2_registe .h	ers This file contains the definitions of the needed peripheral registers.

9.7 **Resource Usage**

Table 9-4 provides an overview of the memory resources used by the code.

Maximum stack usage is 0 bytes.

Table 9-4 Memory resources

Module ROM		RAM (bytes)	
	Code (bytes)	Data (bytes)	-
voltage.o	188	0	0
Total (bytes)	188	0	0

Table 9-5 illustrates the execution time for the specific functions.

Table 9-5 Execution time		
Function	Clock Cycle Count	Time measured (µs) at 240 MHz
VoltageMonitor_Init	30504	127

9.8 **Requirements for Safety Relevant Applications**

Refer to the Safety Manual [REF.4].

10. Requirements for Safety Relevant Applications

Refer to the Safety Manual [REF.4].

11. Appendix A - RAM Test Algorithms

The following algorithm descriptions are related to 1-bit word memory, but can be applied to m-bit memories (wordoriented memory test). The extension to m-bit word is discussed in this appendix.



11.1 Extended March C-

A March Test consists of a finite sequence of elements called March Elements, delimited by a pair of curly brackets `{ }'.

A March Element is a finite sequence of operations applied to a cell before moving to the next one.

March Elements are delimited by a pair of rounded brackets '()'. The next cell is defined with respect to the addressing order, which can be, ascending (\uparrow), descending (\downarrow), or independent (\updownarrow). An operation on a memory cell can be, write 0 (w0), write 1 (w1), read and verify to have read 0 (r0), read and verify to have read 1 (r1).

Extended March C- is represented in Figure 11-1, using the preceding notation described in this section.

```
{c (w0); \uparrow (r0, w1, r1); \uparrow (r1, w0);
\downarrow (r0, w1); \downarrow (r1, w0); c (r0)}
```

Figure 11-1: Extended March C- Algorithm.

The March C- algorithm detects address faults (AFs), stuck at faults (SAFs), transactional faults (TFs), and coupling faults (CFs). In addition, the Extended March C- algorithm also detects stuck open faults (SOFs), and data retention faults (DRF). Its complexity is equal to 11n, where n is the number of addressing cells of the memory.

11.2 **WALPAT**

The WALPAT algorithm follows the process shown below:

```
Write 0 in all cells;
For i=0 to n-1
{ complement cell[i];
For j=0 to n-1, j != i
{ read cell[j]; }
read cell[i];
complement cell[i]; }
Write 1 in all cells;
For i=0 to n-1
{ complement cell[i];
For j=0 to n-1, j != i
{ read cell[j]; }
read cell[j]; }
```

The algorithm allows for the detection and location of address faults (AFs), stuck-at faults (SAFs), transactional faults (TFs), coupling faults (CFs), and sense amplifier recovery faults (SARF). Its complexity is equal to 2n2, where n is the number of addressing cells of the memory.

11.3 Word-oriented Memory Test

m-bit memories can be dealt with by repeating each algorithm for a number of times given by:

 $\lceil \log_2 m \rceil + 1$

For every iteration, w1 operation writes a pattern (for instance, 00000000) and w0 operation writes the complemented value with respect to that used for w1 (1111111).

Taking into account that the code uses 32-bit word access, the algorithm is repeated 6 times, and the following 6 different patterns have to be applied:



12. Appendix B - CPU Test Example

```
#include "coretest.h"
uint8_t s teps=1;
uint32_t re sult=0;
uint8_t forceFai l = 11;
void errorHandler(void);
void main(void)
{
    coreTestInit(); //init index
    steps=36;
    /* Launch the core test function in order to perform Diagnosis SW*/
    coreTest(steps, forceFail, &result);
    if(result != 1) {
        errorHandler();
    }
}
```

13. Appendix C – Pragmas report

Table 13-1 reports the pragmas added in the source code to disable specific checks when using the LDRA tool. Related violations have been reviewed in details and judged as not requiring a change to the code.

Table 13-1 Pragma report



Package	File	Code Version	Row	Code (Pragma)	LDRA Rule	MISRA Rule
				/*LDRA INSPECTED 90 S		
DAM		4.0.4	40	Basic type declaration	000	D 4 0
RAM	testRAM.c	1.0.1	18	used. */	90S	D.4.6
		1.0.1		/*LDRA INSPECTED 90 S Basic type declaration		
RAM	testRAM.c		19	used. */	90S	D.4.6
		1.0.1		/*LDRA INSPECTED 27 D		
				Variable should be		
RAM	testRAM.c		20	declared static. */	27D	R.8.7, R.8.8
		1.0.1		/*LDRA INSPECTED 90 S		
				Basic type declaration		
RAM	testRAM.c	4.0.4	23	used. */	90S	D.4.6
		1.0.1		/*LDRA INSPECTED 90 S		
RAM	testRAM.c		24	Basic type declaration used. */	90S	D.4.6
10.00	cobertani.o	1.0.1		/*LDRA INSPECTED 27 D	000	Dino
				Variable should be		
RAM	testRAM.c		25	declared static. */	27D	R.8.7, R.8.8
		1.0.1	_	/*LDRA INSPECTED 90 S		- ,
		-		Basic type declaration		
RAM	testRAM.c		28	used. */	90S	D.4.6
		1.0.1		/*LDRA INSPECTED 90 S		
			00	Basic type declaration	000	D 4 6
RAM	testRAM.c	101	29	used. */	90S	D.4.6
		1.0.1		/*LDRA INSPECTED 90 S Basic type declaration		
RAM	testRAM.c		30	used. */	90S	D.4.6
		1.0.1		/*LDRA INSPECTED 90 S		-
				Basic type declaration		
RAM	testRAM.c		33	used. */	90S	D.4.6
		1.0.1		/*LDRA INSPECTED 90 S		
			00	Basic type declaration	000	D 4 6
RAM	testRAM.c	101	36	used. */	90S	D.4.6
		1.0.1		/*LDRA INSPECTED 90 S Basic type declaration		
RAM	testRAM.c		38	used. */	90S	D.4.6
		1.0.1		/*LDRA INSPECTED 90 S		
				Basic type declaration		
RAM	testRAM.c		40	used. */	90S	D.4.6
		1.0.1		/*LDRA INSPECTED 90 S		
DAM			40	Basic type declaration	000	
RAM	testRAM.c	1.0.1	43	used. */	90S	D.4.6
		1.0.1		/*LDRA INSPECTED 90 S Basic type declaration		
RAM	testRAM.c		45	used. */	90S	D.4.6
		1.0.1		/*LDRA INSPECTED 90 S		
				Basic type declaration		
RAM	testRAM.c		47	used. */	90S	D.4.6
		1.0.1		/*LDRA INSPECTED 90 S		
			61	Basic type declaration	008	
RAM	testRAM.c		61	used. */	90S	D.4.6



Package	File	Code Version	Row	Code (Pragma)	LDRA Rule	MISRA Rule
		1.0.1		/*LDRA INSPECTED 90 S		
				Basic type declaration		
RAM	testRAM.c		63	used. */	90S	D.4.6
		1.0.1		/*LDRA INSPECTED 90 S		
RAM	testRAM.c		70	Basic type declaration used. */	90S	D.4.6
	00001011.0	1.0.1	10	/*LDRA INSPECTED 90 S	000	0.4.0
		1.0.1		Basic type declaration		
RAM	testRAM.c		72	used. */	90S	D.4.6
		1.0.1		/*LDRA INSPECTED 90 S		
				Basic type declaration	_	
RAM	testRAM.h		25	used. */	90S	D.4.6
		1.0.1		/*LDRA INSPECTED 90 S		
RAM	testRAM.h		27	Basic type declaration used. */	90S	D.4.6
	LESTRAM.II	1.0.1	21	/*LDRA INSPECTED 90 S	903	D.4.0
		1.0.1		Basic type declaration		
RAM	testRAM.h		30	used. */	90S	D.4.6
		1.0.1		/*LDRA INSPECTED 90 S		
				Basic type declaration		
RAM	testRAM.h		31	used. */	90S	D.4.6
		1.0.1		/*LDRA INSPECTED 90 S		
D 4 4 4	_			Basic type declaration		540
RAM	testRAM.h		32	used. */	90S	D.4.6
		1.0.1		/*LDRA INSPECTED 90 S		
ROM	crc.c		21	Basic type declaration used. */	90S	D.4.6
	010.0	1.0.1	21	/*LDRA INSPECTED 90 S	500	0.4.0
		1.0.1		Basic type declaration		
ROM	crc.c		24	used. */	90S	D.4.6
		1.0.1		/*LDRA INSPECTED 90 S		
				Basic type declaration		
ROM	crc.c		79	used. */	90S	D.4.6
		1.0.1		/*LDRA INSPECTED 90 S		
DOM			90	Basic type declaration	000	
ROM	crc.c	1.0.1	80	used. */	90S	D.4.6
		1.0.1		/*LDRA INSPECTED 90 S Basic type declaration		
ROM	crc.c		81	used. */	90S	D.4.6
-		1.0.1	-	/*LDRA INSPECTED 90 S		_
				Basic type declaration		
ROM	crc.c		85	used. */	90S	D.4.6
		1.0.1		/*LDRA INSPECTED 90 S		
				Basic type declaration		
ROM	crc.c		90	used. */	90S	D.4.6
		1.0.1				R.10.1,
				/*LDRA INSPECTED 93 S		R.10.3, P 10.4
				Value is not of appropriate type.		R.10.4, R.10.5,
ROM	crc.c		111	V9.5.0 */	93S	R.11.1
		1.0.1		/*LDRA INSPECTED 90 S		
				Basic type declaration		



Package	File	Code Version	Row	Code (Pragma)	LDRA Rule	MISRA Rule
		1.0.1		/*LDRA INSPECTED 90 S		
501/			~ (Basic type declaration		5 / 0
ROM	crc.h		24	used. */	90S	D.4.6
		1.0.1		/*LDRA INSPECTED 90 S		
ROM	crc.h		25	Basic type declaration used. */	90S	D.4.6
	010.11	1.0.1	20	/*LDRA INSPECTED 90 S	000	Dino
				Basic type declaration		
ROM	crc.h		26	used. */	90S	D.4.6
		1.0.2		/*LDRA INSPECTED 90 S		
	clock_monit			Basic type declaration		
CAC	or.c		67	used. */	90S	D.4.6
		1.0.2		/*LDRA INSPECTED 90 S		
CAC	clock_monit or.c		68	Basic type declaration used. */	90S	D.4.6
0/10	01.0	1.0.2	00	/*LDRA INSPECTED 90 S	000	D.4.0
	clock monit	1.0.2		Basic type declaration		
CAC	or.c		82	used. */	90S	D.4.6
		1.0.2		/*LDRA INSPECTED 90 S		
	clock_monit			Basic type declaration		
CAC	or.c		84	used. */	90S	D.4.6
		1.0.2		/*LDRA INSPECTED 90 S		
C A C	clock_monit		00	Basic type declaration	000	
CAC	or.c	4.0.0	86	used. */	90S	D.4.6
	alaak monit	1.0.2		/*LDRA INSPECTED 90 S		
CAC	clock_monit or.c		89	Basic type declaration used. */	90S	D.4.6
0,10	01.0	1.0.2		/*LDRA INSPECTED 90 S		Brite
	clock monit			Basic type declaration		
CAC	or.c -		91	used. */	90S	D.4.6
		1.0.2		/*LDRA INSPECTED 90 S		
	clock_monit			Basic type declaration		
CAC	or.c		93	used. */	90S	D.4.6
		1.0.2		/*LDRA INSPECTED 90 S		
CAC	clock_monit or.c		107	Basic type declaration used. */	90S	D.4.6
UNU	01.0	1.0.2	107	/*LDRA INSPECTED 90 S	300	D.4.0
	clock monit	1.0.2		Basic type declaration		
CAC	or.c		108	used. */	90S	D.4.6
		1.0.2		/*LDRA INSPECTED 90 S		
	clock_monit			Basic type declaration		
CAC	or.c -		109	used. */	90S	D.4.6
		1.0.2				R.10.1,
				/*LDRA INSPECTED 93 S		R.10.3,
	alook manit			Value is not of		R.10.4, R 10.5
CAC	clock_monit or.c		110	appropriate type. V9.5.0 */	93S	R.10.5, R.11.1
		1.0.2		/*LDRA INSPECTED 90 S		
	clock monit			Basic type declaration		
CAC	or.c -		111	used. */	90S	D.4.6
		1.0.2		/*LDRA INSPECTED 90 S		
	clock_monit			Basic type declaration		
CAC	or.c		112	used. */	90S	D.4.6



Package	File	Code Version	Row	Code (Pragma)	LDRA Rule	MISRA Rule
		1.0.2		/*LDRA INSPECTED 90 S		
	clock_monit			Basic type declaration		
CAC	or.c		117	used. */	90S	D.4.6
		1.0.2		/*LDRA INSPECTED 90 S		
	clock_monit			Basic type declaration		
CAC	or.c		118	used. */	90S	D.4.6
		1.0.2		/*LDRA INSPECTED 90 S		
	clock_monit			Basic type declaration		
CAC	or.c		119	used. */	90S	D.4.6
		1.0.2				R.10.1,
						R.10.3,
				/*LDRA INSPECTED 93 S		R.10.4,
~ ^ ~	clock_monit		100	Value is not of	000	R.10.5,
CAC	or.c	4.0.0	120	appropriate type. */	93S	R.11.1
		1.0.2		/*LDRA INSPECTED 90 S		
CAC	clock_monit		100	Basic type declaration	000	
CAC	or.c		123	used. */	90S	D.4.6
		1.0.2		/*LDRA INSPECTED 90 S		
~ ^~	clock_monit		101	Basic type declaration	000	
CAC	or.c		124	used. */	90S	D.4.6
		1.0.2		/*LDRA INSPECTED 90 S		
~~~	clock_monit		405	Basic type declaration	000	D 4 6
CAC	or.c		125	used. */	90S	D.4.6
		1.0.2		/*LDRA INSPECTED 90 S		
~^~	clock_monit		400	Basic type declaration	000	
CAC	or.c		126	used. */	90S	D.4.6
		1.0.2		/*LDRA INSPECTED 90 S		
~~~	clock_monit		400	Basic type declaration	000	
CAC	or.c	4.0.0	129	used. */	90S	D.4.6
		1.0.2				R.10.1,
				/*LDRA INSPECTED 93 S		R.10.3,
				Value is not of		R.10.4,
CAC	clock_monit		130	appropriate type. V9.5.0 */	93S	R.10.5, R.11.1
CAC	or.c	100	130		933	N.11.1
		1.0.2		/*LDRA INSPECTED 90 S		
CAC	clock_monit or.c		131	Basic type declaration used. */	90S	D.4.6
CAC	01.0	100	131		903	D.4.0
		1.0.2		/*LDRA INSPECTED 90 S		
CAC	clock_monit or.c		132	Basic type declaration used. */	90S	D.4.6
CAC	01.0	1.0.2	152		300	D.4.0
	alaak monit	1.0.2		/*LDRA INSPECTED 90 S Basic type declaration		
CAC	clock_monit or.c		138	used. */	90S	D.4.6
0/10	01.0	1.0.2	100	/*LDRA INSPECTED 90 S	000	D.4.0
	clock monit	1.0.2		Basic type declaration		
CAC	or.c		139	used. */	90S	D.4.6
	~	1.0.2		/*LDRA INSPECTED 90 S		2.1.0
	clock monit	1.0.2		Basic type declaration		
CAC	or.c		140	used. */	90S	D.4.6
0/10	UI.C	1.0.2	140	uscu. /	500	R.10.1,
		1.0.2		/*ldra inspected 93 s		R.10.1, R.10.3,
	clock monit			Value is not of		R.10.3, R.10.4,
CAC	or.c		141	appropriate type. */	93S	R.10.4, R.10.5,
5/10	01.0		1 7 1	appropriate cype. /	000	N.10.J,



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Package	File	Code Version	Row	Code (Pragma)	LDRA Rule	MISRA Rule
						R.11.1
		1.0.2		/*LDRA INSPECTED 90 S		
	clock_monit			Basic type declaration		
CAC	or.c		144	used. */	90S	D.4.6
		1.0.2		/*LDRA INSPECTED 90 S		
CAC	clock_monit or.c		145	Basic type declaration used. */	90S	D.4.6
ORO	01.0	1.0.2	145	/*LDRA INSPECTED 90 S	500	D.4.0
	clock monit	1.0.2		Basic type declaration		
CAC	or.c		148	used. */	90S	D.4.6
		1.0.2				R.10.1,
				/*LDRA INSPECTED 93 S		R.10.3,
				Value is not of		R.10.4,
	clock_monit			appropriate type.		R.10.5,
CAC	or.c		149	V9.5.0 */	93S	R.11.1
		1.0.2		/*LDRA INSPECTED 90 S		
CAC	clock_monit		150	Basic type declaration	000	
CAC	or.c	100	150	used. */	90S	D.4.6
	alaak monit	1.0.2		/*LDRA INSPECTED 90 S Basic type declaration		
CAC	clock_monit or.c		151	used. */	90S	D.4.6
	01.0	1.0.2	101		000	R.10.1,
		1.0.2		/*LDRA INSPECTED 93 S		R.10.3,
				Value is not of		R.10.4,
	clock monit			appropriate type.		R.10.5,
CAC	or.c		177	V9.5.0 */	93S	R.11.1
						R.10.1,
						R.10.3,
				/*LDRA INSPECTED 93 S		R.10.4,
CAC	clock_monit		178	Value is not of	93S	R.10.5,
CAC	or.c	100	170	appropriate type. */	933	R.11.1
		1.0.2		/*ldra inspected 93 s		R.10.1, R.10.3,
				Value is not of		R.10.4,
	clock monit			appropriate type.		R.10.5,
CAC	or.c -		180	V9.5.0 */	93S	R.11.1
						R.10.1,
						R.10.3,
				/*LDRA INSPECTED 93 S		R.10.4,
0.1.0	clock_monit		101	Value is not of		R.10.5,
CAC	or.c	4.6.5	181	appropriate type. */	93S	R.11.1
	·	1.0.2		/*LDRA INSPECTED 90 S		
CAC	clock_monit		58	Basic type declaration	90S	D.4.6
	or.h	1.0.2	50	used. */ /*LDRA INSPECTED 90 S	303	D.4.0
	clock monit	1.0.2		Basic type declaration		



14. Document References

[REF.1] Cortex-M4 Devices – Generic User Guide, first release, 16/12/2010.

[REF.2] Synergy S7 User's Manual: Hardware, Rev. 1.30, January 2018 (Document Reference R01UM0001EU0130).

[REF.3] IAR C/C++ Development Guide Compiling and linking for Advanced RISC Machines Ltd's ARM Cores, Fifteenth edition, March 2015.

[REF.4] Safety Manual, ID=SAF_005_PIA003_S7.



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Revision History

			Description
Rev.	Date	Page	Summary
1.00	Feb 7, 2017	-	Initial version
1.01	Feb 17, 2017	§4.4.1	Inserted clarification in "Reserving and placing the buffer" section.
		§8.4.2	Inserted an additional note on setting of "eVoltage" value
1.02	Feb 23, 2017	§8.4.2	Inserted an additional note on LVD usage for LVD1SR register
1.03	Mar 02, 2017	§2.1	Updated C type implementation assumption
1.04	Mar 09, 2017	§3.5.1	Updated CPU latest release and MD5s.
		§3.6	Updated resource usage to align to "1.0.1".
1.05	March 2018	§5.7	Updated memory resources used by the code crc.o
		§4.4.1	Inserted usage condition to reserve buffer area for RAM non destructive tests.
		§15	Updated reference document for the User's Manual
1.06	July 17, 2018	References	Removed revision information from documentation
		3.6,4.7,7.7,8.7	Corrected Resources usage
1.07	Sep 27, 2018	All	Updated the functional safety version of the IAR Embedded Workbench.
		-	Removed "ADC12 Comparator Software" and TSN "Management Software" chapters.
		-	Updated latest release and MD5s of CPU,RAM,ROM,CAC,IWDT and LVD tests.
		All	Replaced "S7G2" Synergy name with "S7".

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